## BLF7G20LS-140P

# Power LDMOS transistor Rev. 3 — 1 September 2015

**AMPLEON** 

Product data sheet

#### **Product profile** 1.

#### 1.1 General description

140 W LDMOS power transistor for base station applications at frequencies from 1800 MHz to 2000 MHz.

Typical performance

Typical RF performance at  $T_{case} = 25$  °C in a common source class-AB production test circuit.

| Mode of operation | f            | I <sub>Dq</sub> | V <sub>DS</sub> | P <sub>L(AV)</sub> | Gp   | $\eta_{D}$ | ACPR <sub>400k</sub> | ACPR <sub>600k</sub> | <b>EVM</b> <sub>rms</sub> |
|-------------------|--------------|-----------------|-----------------|--------------------|------|------------|----------------------|----------------------|---------------------------|
|                   | (MHz)        | (mA)            | (V)             | (W)                | (dB) | (%)        | (dBc)                | (dBc)                | (%)                       |
| CW                | 1805 to 1880 | 850             | 28              | 125                | 17   | 54         | -                    | -                    | -                         |
| GSM EDGE          | 1805 to 1880 | 850             | 28              | 60                 | 17.5 | 41         | -61                  | -75                  | 2.7                       |

#### 1.2 Features and benefits

- Excellent ruggedness
- High efficiency
- Low R<sub>th</sub> providing excellent thermal stability
- Designed for broadband operation (1800 MHz to 2000 MHz)
- Lower output capacitance for improved performance in Doherty applications
- Designed for low memory effects providing excellent pre-distortability
- Internally matched for ease of use
- Integrated ESD protection
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)

#### 1.3 Applications

RF power amplifiers for base stations and multi carrier applications in the 1800 MHz to 2000 MHz frequency range

## 2. Pinning information

Table 2. Pinning

| I dibio 2. | 9           |     |                   |                  |
|------------|-------------|-----|-------------------|------------------|
| Pin        | Description | Si  | implified outline | Graphic symbol   |
| 1          | drain1      |     | 1 2               |                  |
| 2          | drain2      |     | 5                 | .∟               |
| 3          | gate1       |     |                   | 3                |
| 4          | gate2       |     |                   | 5                |
| 5          | source      | [1] | 3 4               | 4—               |
|            |             |     |                   | l<br>2<br>sym117 |

<sup>[1]</sup> Connected to flange.

## 3. Ordering information

Table 3. Ordering information

| Type number    | Packag | ge                                              |          |
|----------------|--------|-------------------------------------------------|----------|
|                | Name   | Description                                     | Version  |
| BLF7G20LS-140P | -      | earless flanged LDMOST ceramic package; 4 leads | SOT1121B |

## 4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol           | Parameter            | Conditions | Min  | Max  | Unit |
|------------------|----------------------|------------|------|------|------|
| $V_{DS}$         | drain-source voltage |            | -    | 65   | V    |
| $V_{GS}$         | gate-source voltage  |            | -0.5 | +13  | V    |
| T <sub>stg</sub> | storage temperature  |            | -65  | +150 | °C   |
| Tj               | junction temperature |            | -    | 200  | °C   |

## 5. Thermal characteristics

Table 5. Thermal characteristics

| Symbol               | Parameter                                | Conditions                        | Тур  | Unit |
|----------------------|------------------------------------------|-----------------------------------|------|------|
| $R_{\text{th(j-c)}}$ | thermal resistance from junction to case | $T_{case}$ = 80 °C; $P_L$ = 100 W | 0.41 | K/W  |

#### 6. Characteristics

Table 6. Characteristics

 $T_i = 25$  °C; per section unless otherwise specified.

| Symbol               | Parameter                        | Conditions                                                         | Min | Тур  | Max | Unit |
|----------------------|----------------------------------|--------------------------------------------------------------------|-----|------|-----|------|
| V <sub>(BR)DSS</sub> | drain-source breakdown voltage   | $V_{GS} = 0 \text{ V}; I_D = 0.9 \text{ mA}$                       | 65  | -    | -   | V    |
| V <sub>GS(th)</sub>  | gate-source threshold voltage    | $V_{DS}$ = 10 V; $I_{D}$ = 90 mA                                   | 1.5 | 1.9  | 2.3 | V    |
| I <sub>DSS</sub>     | drain leakage current            | $V_{GS} = 0 \text{ V}; V_{DS} = 28 \text{ V}$                      | -   | -    | 2   | μА   |
| I <sub>DSX</sub>     | drain cut-off current            | $V_{GS} = V_{GS(th)} + 3.75 \text{ V};$<br>$V_{DS} = 10 \text{ V}$ | 14  | -    | -   | Α    |
| I <sub>GSS</sub>     | gate leakage current             | $V_{GS} = 11 \text{ V}; V_{DS} = 0 \text{ V}$                      | -   | -    | 200 | nA   |
| g <sub>fs</sub>      | forward transconductance         | $V_{DS}$ = 10 V; $I_{D}$ = 2.5 A                                   | -   | 6.45 | -   | S    |
| $R_{DS(on)}$         | drain-source on-state resistance | $V_{GS} = V_{GS(th)} + 3.75 \text{ V};$ $I_D = 3.15 \text{ A}$     | -   | 0.15 | -   | Ω    |

## 7. Test information

#### Table 7. Application information

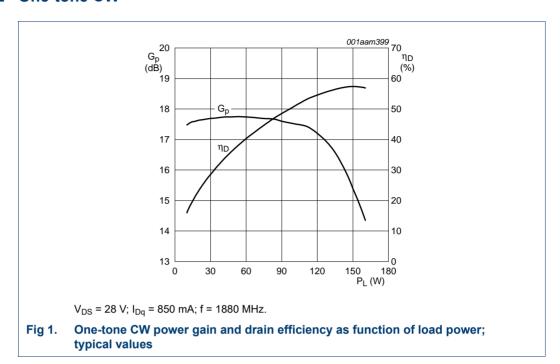
f = 1805 MHz and 1880 MHz; RF performance at  $V_{DS}$  = 28 V;  $I_{Dq}$  = 850 mA;  $T_{case}$  = 25 °C; 2 sections combined unless otherwise specified; in a class-AB production test circuit.

| Symbol        | Parameter                                              | Conditions | Min  | Тур  | Max   | Unit |  |
|---------------|--------------------------------------------------------|------------|------|------|-------|------|--|
| Mode of o     | Mode of operation: GSM EDGE; P <sub>L(AV)</sub> = 60 W |            |      |      |       |      |  |
| Gp            | power gain                                             |            | 16.3 | 17.5 | -     | dB   |  |
| RLin          | input return loss                                      |            | -    | -15  | -8    | dB   |  |
| $\eta_{D}$    | drain efficiency                                       |            | 37   | 41   | -     | %    |  |
| $ACPR_{400k}$ | adjacent channel power ratio (400 kHz)                 |            | -    | -61  | -56.5 | dBc  |  |
| $ACPR_{600k}$ | adjacent channel power ratio (600 kHz)                 |            | -    | -75  | -69.5 | dBc  |  |
| $EVM_{rms}$   | RMS EDGE signal distortion error                       |            | -    | 2.7  | 4.0   | %    |  |
| $EVM_M$       | peak EDGE signal distortion error                      |            | -    | 8.5  | 12.5  | %    |  |
| Mode of o     | peration: CW; P <sub>L(AV)</sub> = 125 W               |            |      |      |       |      |  |
| Gp            | power gain                                             |            | 16   | 17   | -     | dB   |  |
| $\eta_{D}$    | drain efficiency                                       |            | 48   | 54   | -     | %    |  |

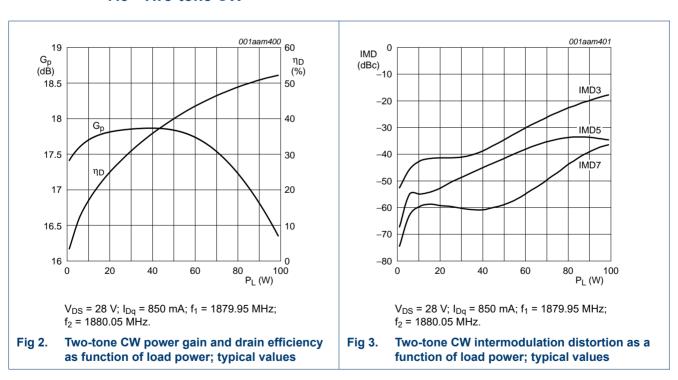
#### 7.1 Ruggedness in class-AB operation

The BLF7G20LS-140P is capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions:  $V_{DS}$  = 28 V;  $I_{Dq}$  = 850 mA;  $P_{L}$  = 140 W (CW); f = 1805 MHz.

#### 7.2 One-tone CW



#### 7.3 Two-tone CW



#### 7.4 GSM EDGE

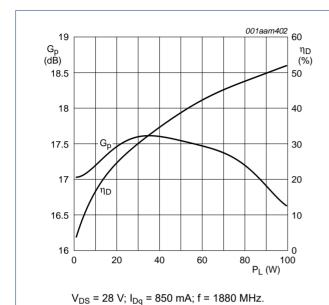
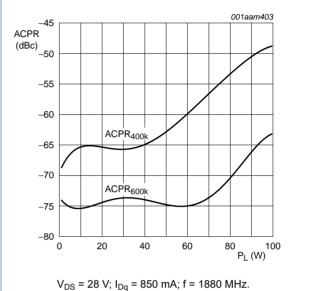
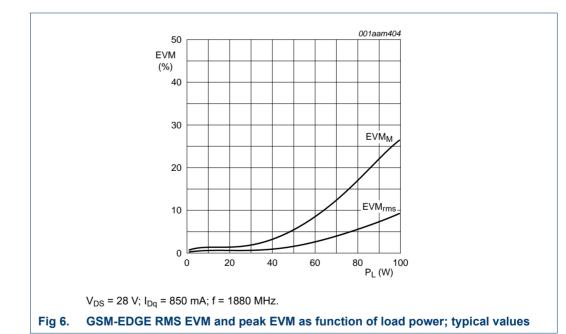


Fig 4. GSM EDGE power gain and drain efficiency as function of load power; typical values



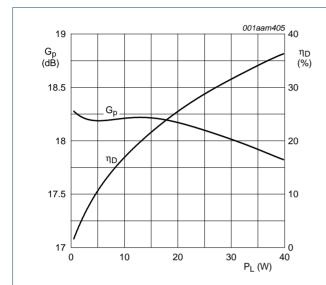
V<sub>DS</sub> = 20 V, I<sub>Dq</sub> = 000 IIIA, I = 1000 IVII I2.

Fig 5. GSM EDGE ACPR at 400 kHz and at 600 kHz as function of load power; typical values



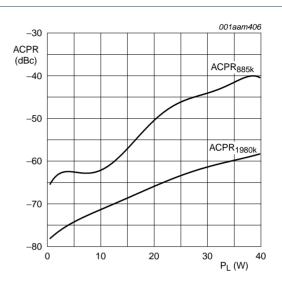
#### 7.5 Single carrier IS-95

Single carrier IS-95 with pilot, paging, sync and 6 traffic channels (Walsh codes 8 - 13). PAR = 9.7 dB at 0.01 % probability on the CCDF. Channel bandwidth is 1.2288 MHz.



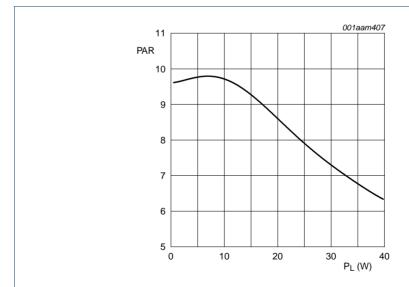
 $V_{DS}$  = 28 V;  $I_{Dq}$  = 1080 mA; f = 1880 MHz.

Fig 7. Single carrier IS-95 power gain and drain efficiency as function of load power; typical values



 $V_{DS} = 28 \text{ V}; I_{Dq} = 1080 \text{ mA}; f = 1880 \text{ MHz}.$ 

Fig 8. Single carrier IS-95 ACPR at 885 kHz and at 1980 kHz as function of load power; typical values

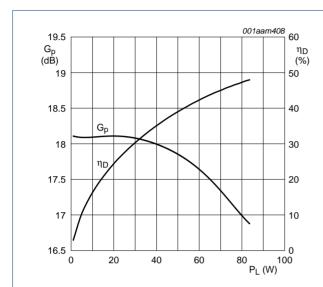


 $V_{DS}$  = 28 V;  $I_{Dq}$  = 1080 mA; f = 1880 MHz.

Fig 9. Single carrier IS-95 peak-to-average power ratio as a function of load power; typical values

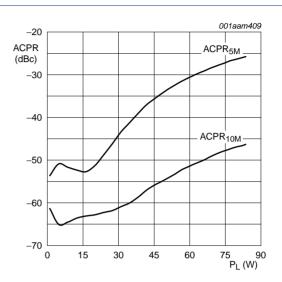
#### 7.6 Single carrier W-CDMA

3GPP; test model 1; 64 DPCH; PAR = 7.2 dB at 0.01 % probability on CCDF. Channel bandwidth is 3.84 MHz.



 $V_{DS} = 28 \text{ V}; I_{Dq} = 1080 \text{ mA}; f = 1880 \text{ MHz}.$ 

Fig 10. Single carrier W-CDMA power gain and drain efficiency as function of load power; typical values



 $V_{DS} = 28 \text{ V}; I_{Dq} = 1080 \text{ mA}; f = 1880 \text{ MHz}.$ 

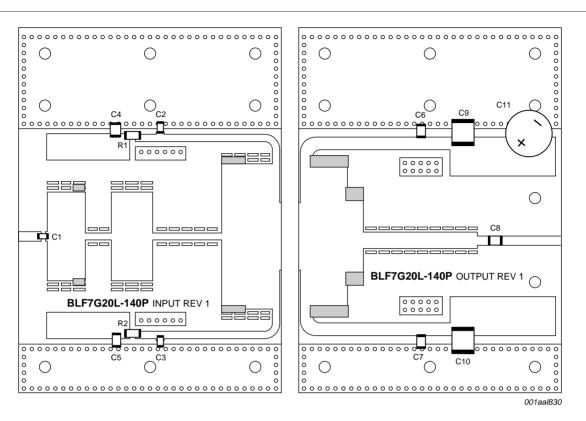
Fig 11. Single carrier W-CDMA ACPR at 5 MHz and at 10 MHz as function of load power; typical values

#### 7.7 Test circuit

Table 8. List of components For test circuit see Figure 12.

| Component  | Description                       | Value        | Remarks      |
|------------|-----------------------------------|--------------|--------------|
| C1, C2, C3 | multilayer ceramic chip capacitor | 24 pF        | <u>[1]</u>   |
| C4, C5     | multilayer ceramic chip capacitor | 4.7 μF       | [2]          |
| C6, C7, C8 | multilayer ceramic chip capacitor | 11 pF        | <u>[3]</u>   |
| C9, C10    | multilayer ceramic chip capacitor | 10 μF        | [2]          |
| C11        | electrolytic capacitor            | 470 μF; 63 V |              |
| R1, R2     | SMD resistor                      | 12 Ω         | Philips 1206 |

- [1] American Technical Ceramics type 100A or capacitor of same quality.
- [2] TDK or capacitor of same quality.
- [3] American Technical Ceramics type 100B or capacitor of same quality.



Printed-Circuit Board (PCB): Taconic RF35;  $\epsilon_r$  = 3.5 F/m; thickness = 0.76 mm; thickness copper plating = 35  $\mu$ m. See Table 8 for a list of components.

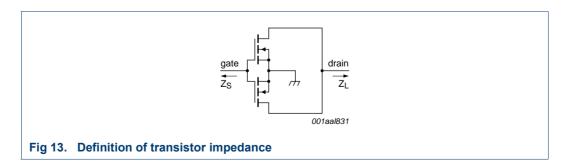
Fig 12. Component layout for class-AB production test circuit

## 7.8 Impedance information

Table 9. Typical impedance

Typical values valid for both section in parallel unless otherwise specified.

| f    | Z <sub>S</sub> | Z <sub>L</sub> |
|------|----------------|----------------|
| MHz  | Ω              | Ω              |
| 1800 | 1.1 – j3.8     | 1.8 – j2.8     |
| 1840 | 1.3 – j3.7     | 1.7 – j2.6     |
| 1880 | 1.2 – j3.8     | 1.6 – j2.5     |



## 8. Package outline

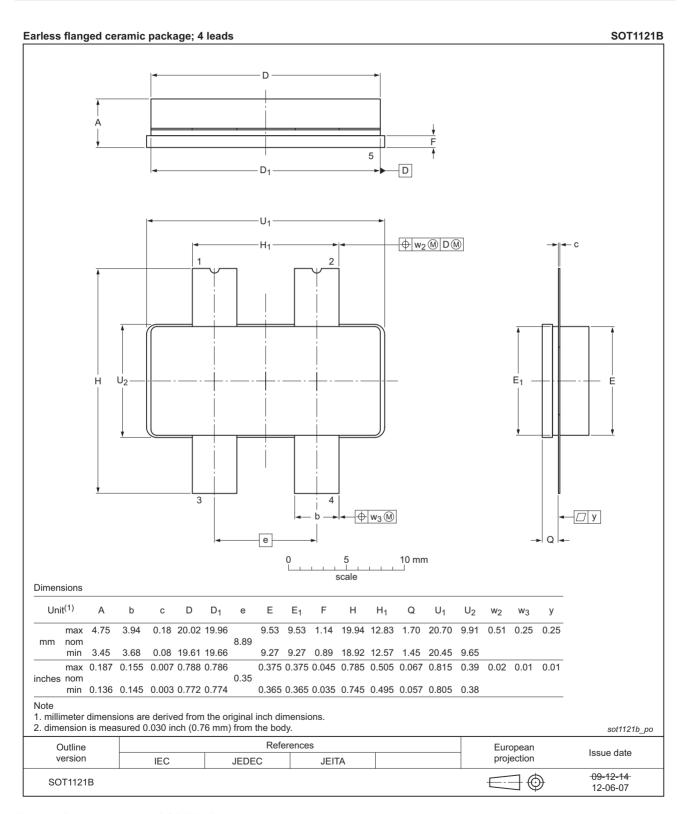


Fig 14. Package outline SOT1121B

## 9. Abbreviations

Table 10. Abbreviations

| Acronym | Description                                             |
|---------|---------------------------------------------------------|
| CW      | Continuous Wave                                         |
| EDGE    | Enhanced Data rates for GSM Evolution                   |
| ESD     | ElectroStatic Discharge                                 |
| GSM     | Global System for Mobile communications                 |
| IS-95   | Interim Standard 95                                     |
| LDMOS   | Laterally Diffused Metal Oxide Semiconductor            |
| LDMOST  | Laterally Diffused Metal Oxide Semiconductor Transistor |
| RF      | Radio Frequency                                         |
| SMD     | Surface Mounted Device                                  |
| VSWR    | Voltage Standing Wave Ratio                             |
| W-CDMA  | Wideband Code Division Multiple Access                  |

## 10. Revision history

Table 11. Revision history

| Document ID                   | Release date                                                                                                                   | Data sheet status    | Change notice | Supersedes                        |
|-------------------------------|--------------------------------------------------------------------------------------------------------------------------------|----------------------|---------------|-----------------------------------|
| BLF7G20LS-140P#3              | 20150901                                                                                                                       | Product data sheet   | -             | BLF7G20LS-140P<br>v.2             |
| Modifications:                | <ul> <li>The format of this document has been redesigned to comply with the new<br/>identity guidelines of Ampleon.</li> </ul> |                      |               |                                   |
|                               | <ul> <li>Legal texts have been adapted to the new company name where<br/>appropriate.</li> </ul>                               |                      |               | me where                          |
| BLF7G20LS-140P v.2            | 20100817                                                                                                                       | Product data sheet   | -             | BLF7G20L-140P_<br>7G20LS-140P v.1 |
| BLF7G20L-140P_7G20LS-140P v.1 | 20100421                                                                                                                       | Objective data sheet | -             | -                                 |

## 11. Legal information

#### 11.1 Data sheet status

| Document status[1][2]          | Product status[3] | Definition                                                                            |  |
|--------------------------------|-------------------|---------------------------------------------------------------------------------------|--|
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## **AMPLEON**

## BLF7G20LS-140P

#### **Power LDMOS transistor**

## 13. Contents

| 1    | Product profile                  | . 1 |
|------|----------------------------------|-----|
| 1.1  | General description              | . 1 |
| 1.2  | Features and benefits            |     |
| 1.3  | Applications                     | . 1 |
| 2    | Pinning information              | 2   |
| 3    | Ordering information             | . 2 |
| 4    | Limiting values                  | . 2 |
| 5    | Thermal characteristics          | . 2 |
| 6    | Characteristics                  | . 3 |
| 7    | Test information                 | . 3 |
| 7.1  | Ruggedness in class-AB operation | . 3 |
| 7.2  | One-tone CW                      |     |
| 7.3  | Two-tone CW                      | 4   |
| 7.4  | GSM EDGE                         |     |
| 7.5  | Single carrier IS-95             |     |
| 7.6  | Single carrier W-CDMA            |     |
| 7.7  | Test circuit                     |     |
| 7.8  | Impedance information            |     |
| 8    | Package outline                  | 9   |
| 9    | Abbreviations                    | 10  |
| 10   | Revision history                 | 10  |
| 11   | Legal information                | 11  |
| 11.1 | Data sheet status                | 11  |
| 11.2 | Definitions                      | 11  |
| 11.3 | Disclaimers                      | 11  |
| 11.4 | Trademarks                       | 12  |
| 12   | Contact information              | 12  |
| 40   | Contento                         | 42  |

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